TOSHIBA Diode Silicon Epitaxial Schottky Barrier Type

# **1SS413**

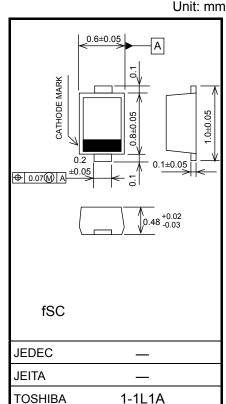
#### High Speed Switching Application

•	Low forward voltage	: V <sub>F (3)</sub> = 0.50V (typ.)
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- Low reverse current : I<sub>R</sub>= 0.5µA (max)
- $: C_T = 3.9 pF (typ.)$ Small total capacitance

#### Absolute Maximum Ratings (Ta = 25°C)

Characteristic	Symbol	Rating	Unit	
Maximum (peak) reverse Voltage	V <sub>RM</sub>	25	V	
Reverse voltage	V <sub>R</sub>	20	V	
Maximum (peak) forward current	I <sub>FM</sub>	100	mA	
Average forward current	Ι <sub>Ο</sub>	50	mA	
Surge current (10ms)	I <sub>FSM</sub>	1	А	
Power dissipation	P *	100	mW	
Junction temperature	Tj	125	°C	
Storage temperature range	T <sub>stg</sub>	-55~125	°C	



Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in

Weight:0.0006g(typ.)

temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Mounted on a glass epoxy circuit board of 20 × 20 mm, pad dimension of 4 × 4 mm.

#### **Electrical Characteristics (Ta = 25°C)**

Characteristic	Symbol	Test Circuit	Test Condition	Min	Тур.	Max	Unit
	V <sub>F (1)</sub>	_	I <sub>F</sub> = 1mA	_	0.33	_	
Forward voltage	V <sub>F (2)</sub>	-	I <sub>F</sub> = 5mA	_	0.38	_	V
	V <sub>F (3)</sub>	-	I <sub>F</sub> = 50mA	_	0.50	0.55	
Reverse current	I <sub>R</sub>	_	V <sub>R</sub> = 20V	_	_	0.5	μA
Total capacitance	CT	—	V <sub>R</sub> = 0, f = 1MH <sub>z</sub>	_	3.9	_	pF

#### Equivalent Circuit (Top View)

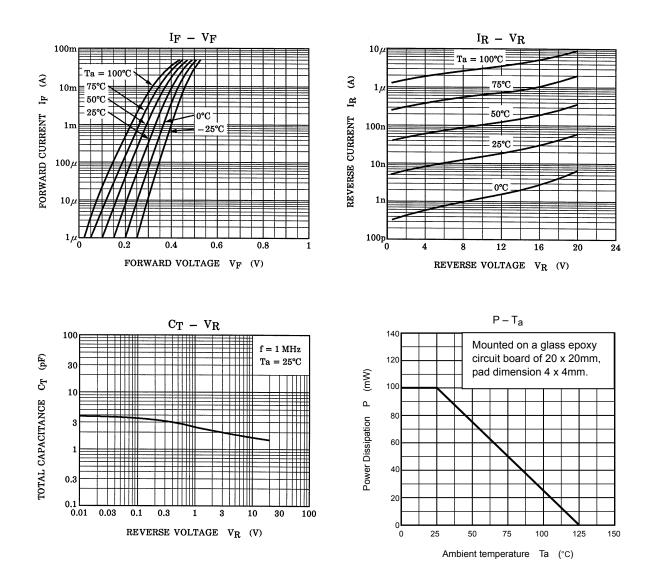
#### Marking





Unit: mm

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